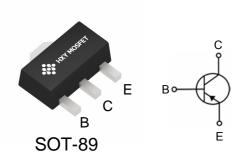


- Power Transistor
- High Voltage and Current
- Low Collector-emitter saturation voltage

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)	
2SB1260	SOT-89	ZL	1000	



Maximum Ratings (Ta=25 unless otherwise noted)

Symbol	Parameter	Value	Unit
V _{CBO}	Collector-Base Voltage	-80	V
V _{CEO}	Collector-Emitter Voltage	-80	V
V _{EBO}	Emitter-Base Voltage	-5	V
Ic	Collector Current	-1	Α
Pc	Collector Power Dissipation	500	mW
R _{OJA}	Thermal Resistance From Junction To Ambient	250	°C/W
T_J, T_stg	Operation Junction and Storage Temperature Range	-55~+150	℃

Electrical Characteristics (Ta=25 unless otherwise specified)

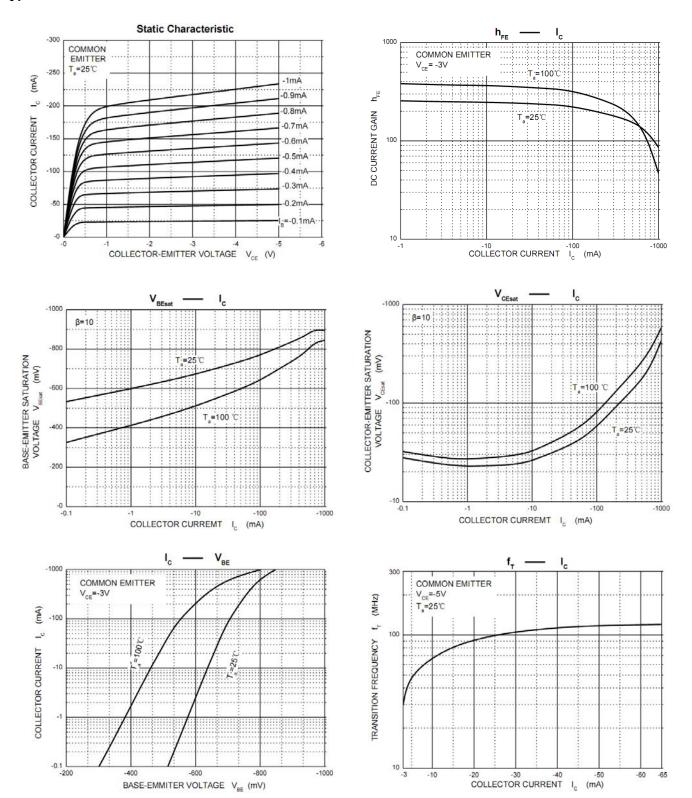
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Collector-base breakdown voltage	V _{(BR)CBO}	I _C =-50μA, I _E =0	-80			V
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =-1mA, I _B =0	-80			V
Emitter-base breakdown voltage	V _{(BR)EBO}	I _E =-50µA, I _C =0	-5			V
Collector cut-off current	I _{CBO}	V _{CB} =-60V, I _E =0			-1	μA
Collector cut-off current	I _{CEO}	V _{CE} =-60V, I _B =0			-1	μΑ
Emitter-base breakdown voltage	I _{EBO}	V _{EB} =-4V, I _C =0			-0.1	μA
DC current gain	h _{FE(1)}	V _{CE} =-3V, Ic=-0.1A	120		390	
Collector-emitter saturation voltage	V _{CE(sat)}	I _C =-500mA, I _B =-50mA			-0.4	V
Collector output capacitance	C _{ob}	V _{CB} =-10V, I _E =0,f=1MHz		25		pF
Transition frequency	f⊤	V _{CE} =-1V,I _C =-100mA, f=30MHz		100		MHz

Classifiction Of hFE

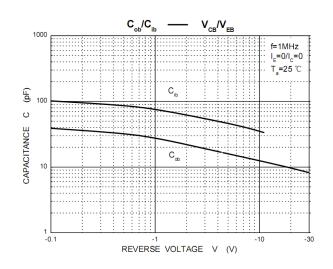
Rank	2SB1260T100Q	2SB1260T100R	
Range	120-270	180-390	
Marking	ZL		

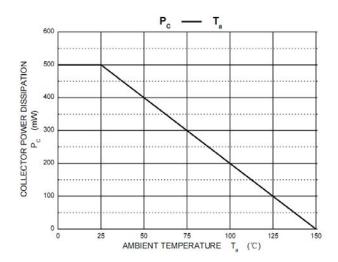


Typical Characteristics

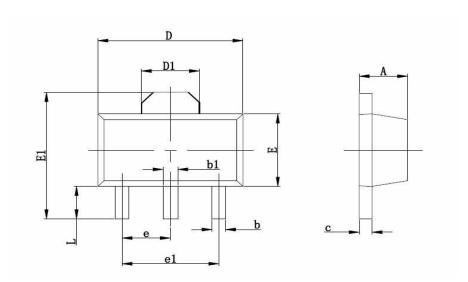








SOT-89 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	1.400	1.600	0.055	0.063	
b	0.320	0.520	0.013	0.020	
b1	0.400	0.580	0.016	0.023	
С	0.350	0.440	0.014	0.017	
D	4.400	4.600	0.173	0.181	
D1	1.550 REF.		0.061 REF.		
E	2.300	2.600	0.091	0.102	
E1	3.940	4.250	0.155	0.167	
е	1.500 TYP.		0.060 TYP.		
e1	3.000 TYP.		0.118 TYP.		
L	0.900	1.200	0.035	0.047	



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